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- 3-State Outputs Drive Bus Lines Directly
- PNP Inputs Reduce dc Loading on Bus Lines
- Hysteresis at Bus Inputs Improves Noise Margins
- Typical Propagation Delay Times Port to Port, 8 ns

TYPE	^I OL (SINK CURRENT)	I _{OH} (SOURCE CURRENT)
SN54LS245	12 mA	–12 mA
SN74LS245	24 mA	–15 mA

description

These octal bus transceivers are designed for asynchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements.

The devices allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable $\overline{(OE)}$ input can disable the device so that the buses are effectively isolated.

SN54LS245,	SN74LS245
OCTAL BUS TRA	NSCEIVERS
WITH 3-STAT	E OUTPUTS
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SN54LS245...J OR W PACKAGE SN74LS245...DB, DW, N, OR NS PACKAGE (TOP VIEW)

SDLS

				1
DIR [1	U	20	Vcc
A1 [2		19] OE
A2 [3		18] B1
A3 [4		17] B2
A4 [5		16] B3
A5 [6		15] B4
A6 [7		14] B5
A7 [8		13] B6
A8 [9		12] B7
GND [10		11] B8

SN54LS245 ... FK PACKAGE (TOP VIEW)

	A2 A1 DIR <u>VC</u> C
A3	3 2 1 20 19 4 18 B1
A3 A4 A5 A6 A7	4 7 120 18 B1 5 17 B2 6 16 B3
A5	6 16 B3
A6	7 15 B4
A7	8 14 B5
	<u>9 10 11 12 13</u>
	A8 GND B8 B7 B6

ORDERING INFORMATION

т _А	PACKAGE		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
	PDIP – N	Tube	SN74LS245N	SN74LS245N	
	SOIC - DW	Tube	SN74LS245DW	LS245	
0°C to 70°C	3010 - DW	Tape and reel	SN74LS245DWR	L0243	
	SOP – NS	Tape and reel	SN74LS245NSR	74LS245	
	SSOP – DB	Tape and reel	SN74LS245DBR	LS245	
	CDIP – J	Tube	SN54LS245J	SN54LS245J	
–55°C to 125°C		Tube	SNJ54LS245J	SNJ54LS245J	
-55°C 10 125°C	CFP – W	Tube	SNJ54LS245W	SNJ54LS245W	
	LCCC – FK	Tube	SN54LS245FK	SN54LS245FK	

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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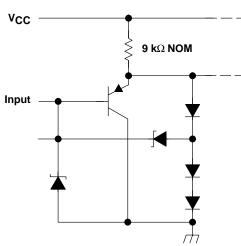
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FUNCTION TABLE

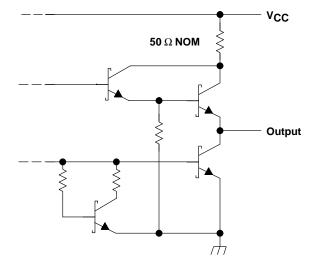
INP	UTS	
ŌĒ	DIR	OPERATION
L L		B data to A bus
L	н	A data to B bus
н	Х	Isolation

schematics of inputs and outputs

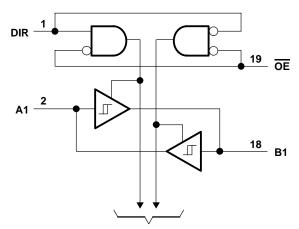








logic diagram (positive logic)



To Seven Other Channels



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC} Input voltage, V _I (see Note 1)		
Package thermal impedance, θ_{JA} (see Note 2):		
	DW package	
	N package	69°C/W
	NS package	60°C/W
Storage temperature range, T _{stg}		–65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values are with respect to GND.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

		SN54LS245		SN74LS245				
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
ЮН	High-level output current			-12			-15	mA
IOL	Low-level output current			12			24	mA
Т _А	Operating free-air temperature	-55		125	0		70	°C



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

					SI	N54LS24	45	SI	N74LS24	45	
PARAMETER		TEST CONDITIONS [†]		MIN	түр‡	MAX	MIN	түр‡	MAX	UNIT	
VIH	High-level input v	oltage			2			2			V
VIL	Low-level input vo	oltage					0.7			0.8	V
VIK	Input clamp volta	ge	V _{CC} = MIN,	lj = -18 mA			-1.5			-1.5	V
	Hysteresis (V _{T+} -	– V _T _) A or B	V _{CC} = MIN		0.2	0.4		0.2	0.4		V
	LPak Ison Level and		$V_{CC} = MIN,$	I _{OH} = –3 mA	2.4	3.4		2.4	3.4		v
Vон	High-level output	voitage	$V_{IH} = 2 V,$ $V_{IL} = V_{IL(max)}$	I _{OH} = MAX	2			2			
Val	Low-level output	voltaga	$V_{CC} = MIN,$	I _{OL} = 12 mA			0.4			0.4	V
VOL		voltage	$V_{IH} = 2 V,$ $V_{IL} = V_{IL(max)}$	I _{OL} = 24 mA						0.5	
IOZH	Off-state output c high-level voltage	,	<u>VC</u> C = MAX, OE at 2 V	V _O = 2.7 V			20			20	μΑ
IOZL	Off-state output c low-level voltage		<u>V_C</u> C = MAX, OE at 2 V	V _O = 0.4 V			-200			-200	μΑ
	Input current at	A or B		V _I = 5.5 V			0.1			0.1	
łį	maximum input voltage	DIR or OE	V _{CC} = MAX	V _I = 7 V			0.1			0.1	mA
IIН	High-level input c	urrent	V _{CC} = MAX,	V _{IH} = 2.7 V			20			20	μA
١ _{IL}	Low-level input c	urrent	V _{CC} = MAX,	V _{IL} = 0.4 V			-0.2			-0.2	mA
los	Short-circuit outp	ut current§	V _{CC} = MAX		-40		-225	40		-225	mA
		Total, outputs high				48	70		48	70	
ICC	Supply current	Total, outputs low	V _{CC} = MAX	Outputs open		62	90		62	90	mA
		Outputs at high Z				64	95		64	95	

[†] For conditions shown as MIN or MAX, use the appropriate values specified under recommended operating conditions.

[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C.

§ Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

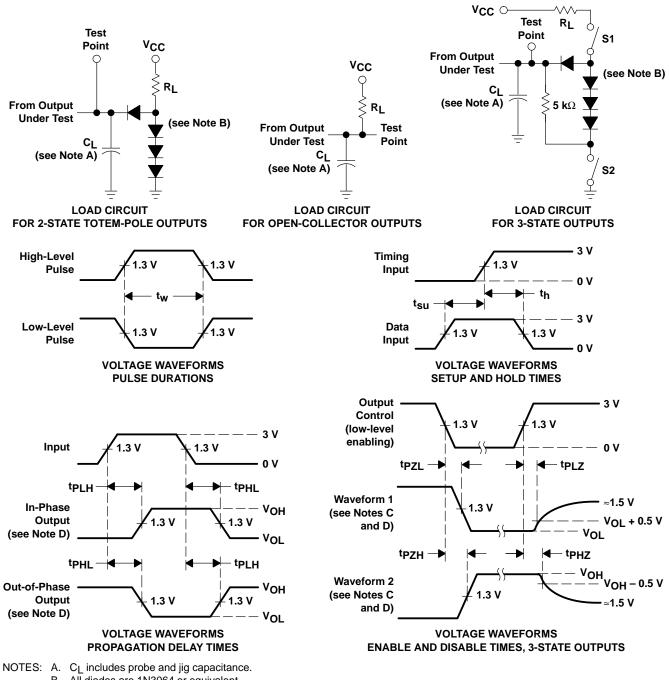
switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 1)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
^t PLH	Propagation delay time, low- to high-level output	0. 45 *5	D. 007.0		8	12	
^t PHL	Propagation delay time, high- to low-level output	C _L = 45 pF,	R _L = 667 Ω		8	12	ns
^t PZL	Output enable time to low level	C ₁ = 45 pF,	Rι = 667 Ω		27	40	20
^t PZH	Output enable time to high level	CL = 45 pr,	KL = 007 S2		25	40	ns
^t PLZ	Output disable time from low level	Ci – 5 pE	R _I = 667 Ω		15	25	ns
^t PHZ	Output disable time from high level	C _L = 5 pF,	KL = 007 52		15	28	115



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PARAMETER MEASUREMENT INFORMATION SERIES 54LS/74LS DEVICES



- B. All diodes are 1N3064 or equivalent.
 - C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - D. S1 and S2 are closed for tpLH, tpHL, tpHZ, and tpLZ; S1 is open and S2 is closed for tpZH; S1 is closed and S2 is open for tpZL.
 E. Phase relationships between inputs and outputs have been chosen arbitrarily for these examples.
 - F. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_{O} \approx 50 \Omega$, $t_{r} \leq$ 1.5 ns, $t_{f} \leq$ 2.6 ns.
 - G. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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